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| Title of Change: | Change to BelaSigna 300 to overcome potential boot issue on small percentage of parts | |
| Proposed first ship date: | 3 August 2015 | |
| Contact information: | Contact your local ON Semiconductor Sales Office | |
| Type of notification: | ON Semiconductor considers this change approved unless specific conditions of acceptance are provided in writing. To do so, contact <PCN.Support@onsemi.com>. | |
| Change category(s): <input type="checkbox"/> Wafer Fab Change <input type="checkbox"/> Manufacturing Site Change/Addition <input checked="" type="checkbox"/> Product specific change <input type="checkbox"/> Assembly Change <input type="checkbox"/> Manufacturing Process Change <input type="checkbox"/> Datasheet/Product Doc change <input type="checkbox"/> Test Change <input type="checkbox"/> Material Change <input type="checkbox"/> Shipping/Packaging/Marking <input type="checkbox"/> Other: _____ | | |
| Sites Affected: <input type="checkbox"/> All site(s) <input checked="" type="checkbox"/> not applicable <input type="checkbox"/> ON Semiconductor site(s) : <input type="checkbox"/> External Foundry/Subcon site(s): | <u>Site 1</u> | <u>Site 2</u> |
| Description and Purpose: The VDDC regulator design has been changed in order to avoid an overvoltage on VDDC when powering up VBAT with a voltage above 1.32 V. The VDDC overvoltage could lead to start-up failures of the device | | |
| List of affected Standard Parts: B300W35A102XYG | | |